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Part Number:	0430450825		
Status:	Active		
Overview: microfit 30			
Description:		Micro-Fit 3.0™ Header, Surface Mount Compatible, Dual Row,	
Description:		Micro-Fit S.0 ¹ ^m Header, Sufface Mount Compatible, Dual Row, Metal Retention Clip, 8 Circuits, 0.38µm (15µ") Gold (Au)	
Selective Plating, G			
	Selective Flating, Glo		
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Documents:			(Production of the second seco
<u>3D Model</u>		Product Specification PS-43045 (PDF)	worder () w
Drawing (PDF)		RoHS Certificate of Compliance (PDF)	Series
			- image - Reference only
Agency Certifi	cation		
CSA		LR19980	EU RoHS China RoHS
TUV		R72081037	ELV and RoHS
UL		E29179	Compliant
			REACH SVHC
General			Contains SVHC: No
Product Family		PCB Headers	Halogen-Free
Series		43045	Status
Application		Wire-to-Board	Halogen-Free
Comments		High Temperature Square Pin Offset Through Hole	Need more information on product
		Mounting/Solder Type	environmental compliance?
Overview		microfit_30	
Product Literature	Order No	USA-106	Email productcompliance@molex.com
Product Name		Micro-Fit 3.0™	For a multiple part number RoHS Certificate of
			Compliance, <u>click here</u>
Physical			
Breakaway		No	Please visit the <u>Contact Us</u> section for any
Circuits (Loaded)		8	non-product compliance questions.
Circuits (maximum)		8	
Color - Resin		Black	
Durability (mating cycles max)		30	
Flammability		94V-0	Search Parts in this Series
Glow-Wire Compliant		Yes	<u>43045</u> Series
Mated Height (in)		0.680 In	
Mated Height (mm)		17.27 mm	Mates With
Material - Metal		Brass	43025
Material - Plating M	Mating	Gold	·
Material - Plating 1	Fermination	Tin	
Material - Resin		High Temperature Thermoplastic	
Number of Rows		2	
Orientation		Vertical	
PCB Locator		Yes	
PCB Retention		Yes	
PCB Thickness Re		0.062 In	
PCB Thickness Recommended (mm)		1.60 mm	
Packaging Type		Tray	
Pitch - Mating Interface (in)		0.118 ln	
Pitch - Mating Interface (mm)		3.00 mm	
Plating min: Mating (µin)		15	
Plating min: Mating (µm)		0.38	
Plating min: Termination (µin)		100	
Plating min: Termination (µm)		2.50	
Polarized to PCB		Yes	
Shrouded		Fully	
Stackable		No	
1			

Surface Mount Compatible (SMC) Temperature Range - Operating Termination Interface: Style	Yes -40°C to +105°C Through Hole - Kinked Pin
Electrical Current - Maximum per Contact Voltage - Maximum	5A 250V
Solder Process Data Duration at Max. Process Temperature (seconds) Lead-free Process Capability Max. Cycles at Max. Process Temperature Process Temperature max. C	30 SMC & Wave Capable (TH only) 3 260
Material Info	
Reference - Drawing Numbers Packaging Specification Product Specification Sales Drawing Test Summary	PK-70873-0314 PS-43045, RPS-43045-003, RPS- SD-43045-009 TS-43045-001, TS-43045-002

RPS-43045-004 SD-43045-009 TS-43045-001, TS-43045-002

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